

/ Descriptions

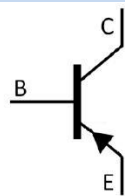
TO-92 PNP

/ Features

FBET MBIT , ,

/ Applications

/ Equivalent Circuit



/ Pinning



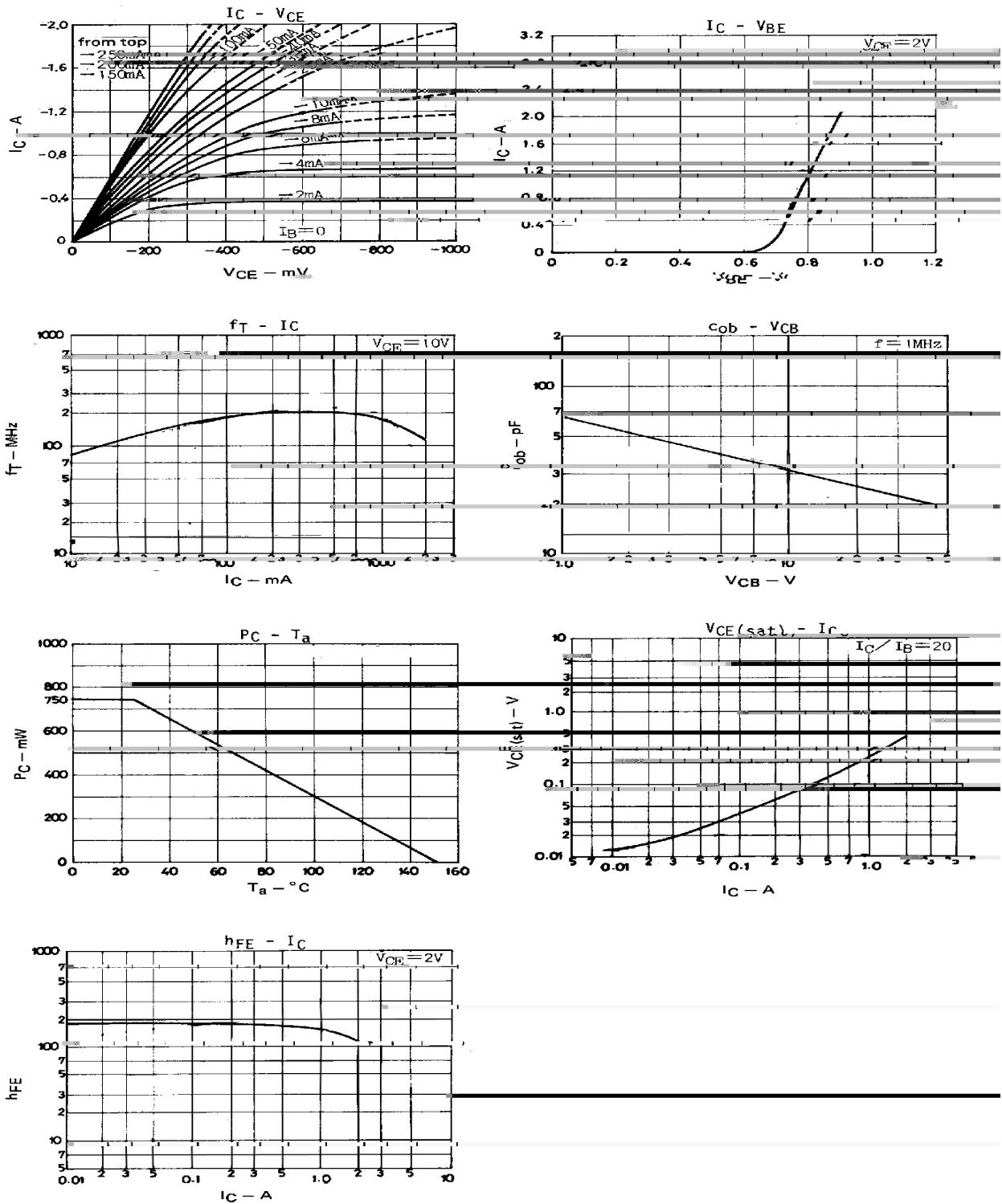
/ hFE Classifications & Marking

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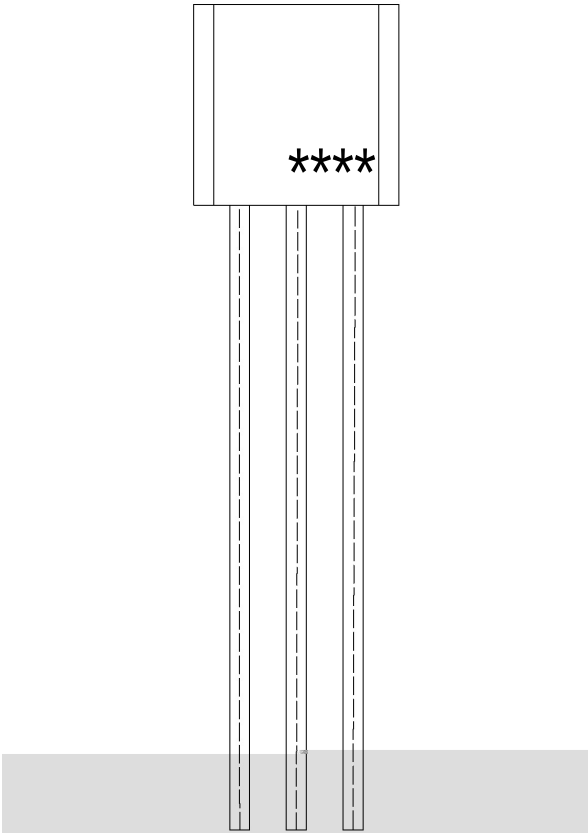
			℃
			℃

		μ				
		μ				
						μ
						μ

/ Electrical Characteristic Curve

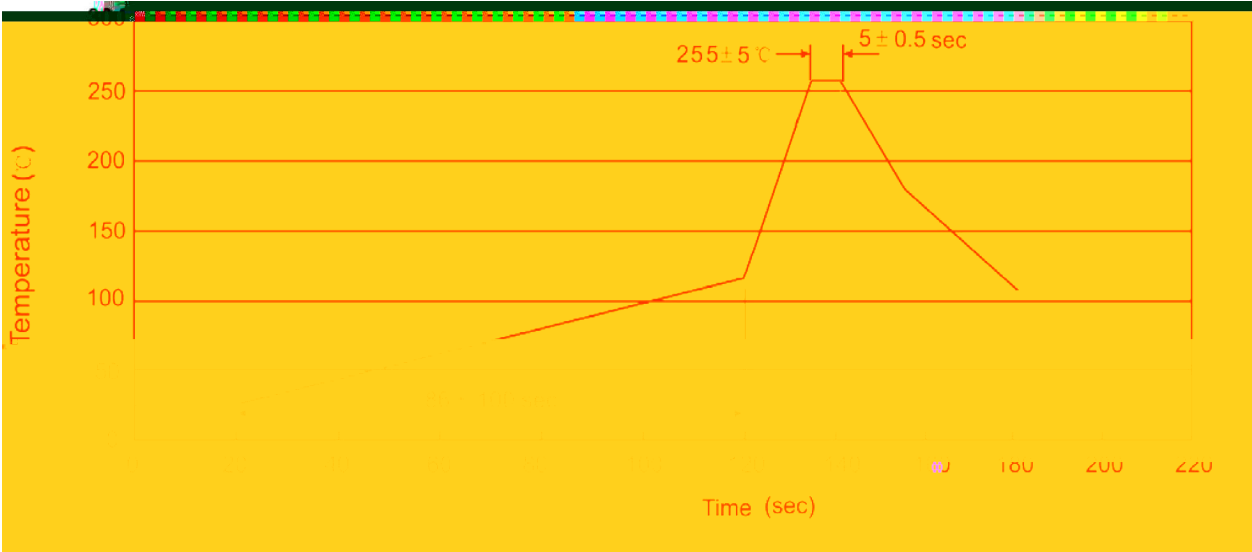


/ Marking Instructions



BR:
B926
R:

() / Temperature Profile for Dip Soldering(Pb-Free)



± ± ± ±

/ Resistance to Soldering Heat Test Conditions

± ± °C

/ Packaging SPEC.

封装形式	包装数量					包装尺寸 :		
	Units/Bag 只/袋	Bags/Inner Box 袋/盒	Units/Inner Box 只/盒	Inner Boxes/Outer Box 盒/箱	Units/Outer Box 只/箱	Bag 袋	Inner Box 盒	Outer Box 箱
TO-92	1,000	10	10,000	5	50,000	135×190	237×172×102	560×245×195
	1,000	10	10,000	10	100,000	135×190	237×172×102	560×245×375

封装形式	包装数量					包装尺寸 :	
	Units/tape 只/纸带	Tape/Inner Box 纸带/盒	Rows/Inner Box 纸带层/盒	Inner Boxes/Outer Box 盒/箱	Units/Outer Box 只/箱	Inner Box 盒	Outer Box 箱
TO-92	3,000	1	120	10	30,000	328×230×42	小箱 480×346×235, 大箱 547×407×268

/ Notices